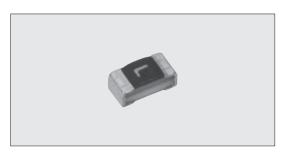
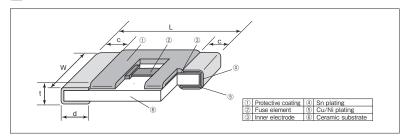


TF10BN Chip Current Fuses



Coating color : Black

■ Construction



Features

- 1005 size miniature and light chip current fuses for the secondary circuit. An occupied area reducible.
- Excellent in mechanical strength.
- The original construction and manufacturing method make the fusing characteristics stable.
- Low power consumption and less voltage dropping possible due to low internal resistance.
- Suitable for over current protection of circuit block in small electronic devices.
- · Suitable for both reflow and flow soldering.
- Products meet EU-RoHS requirements.

■Approvals Awarded

UL248.14 File No. E131375 c-UL (CSA) C22.2 No. 248.14 File No. E131375

Applications

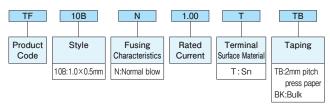
- Cellular-telephones
- Digital still cameras
- Notebook personal computers

■Dimensions

Туре		Weight (g)				
(Inch Size Code)	L	W	С	d	t	(1000pcs)
TF10BN (0402)	1.0±0.1	0.5±0.05	0.2±0.1	0.25±0.1	0.4±0.05	0.68

■Type Designation

Example



Contact us when you have control request for environmental hazardous material other than the substance specified by EU-RoHS.

For further information on taping, please refer to APPENDIX C on the back pages.

Ratings

Type	Marking	Rated Current	Fusing Time	Internal R. (mΩ) Max.	Rated Voltage	Rated Ambient Temp.	Operating Temperature Range	Taping & Q'ty/Reel (pcs)
TF10BN0.20	А	0.20A	Open within 5s at 200% rated current. Refer to the graph of fusing characteristics.	1990		32V +70°C	-55~+125℃	10,000
TF10BN0.25	С	0.25A		1270				
TF10BN0.315	D	0.315A		850				
TF10BN0.50	F	0.50A		320	DC 32V			
TF10BN0.63	ı	0.63A		200				
TF10BN0.80	K	0.80A		135				
TF10BN1.00	L	1.00A		115				
TF10BN1.25	М	1.25A		90				
TF10BN1.60	N	1.60A		58				
TF10BN2.00	S	2.00A		42				
TF10BN2.50	Т	2.50A		35				
TF10BN3.00	V	3.00A		30				
TF10BN3.50	R	3.50A		27				
TF10BN4.00	Х	4.00A		23				
TF10BN5.00	Y	5.00A		19				

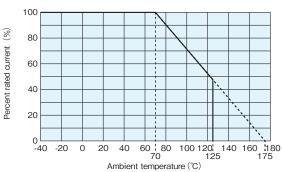


Derating

- Stationary current
 - Regard the peak of stationary current waveform as stationary current value when the stationary current is repeated pulse.
- Temperature Derating

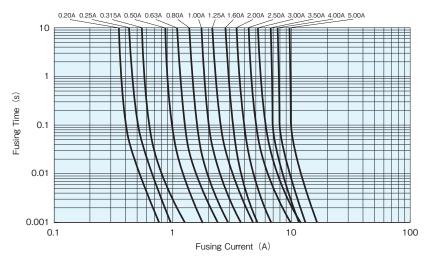
Rated current needs to be derated if used at an ambient temperature 70% or higher. Refer to the derating coefficient on the right figure.

■Rated Current Derating



■ Fusing Characteristics (Average Fusing Time)

TF10BN I-t



■Performance

Test Items	Performance Requirements	ΔR±%	Test Methods		
	Limit	Typical			
Fusing characteristics	Within 5s	_	200% of rated current shall be carried. (at 25°C)		
Bending test	No mechanical damages.	_	Distance between holding points 90mm, bending width 3mm, 1time		
Resistance to soldering heat	10	5	260°C±3°C, 5s ⁺¹ ₋₀ s		
Solderability	95% coverage min.	_	245°C±3°C, 3s±0.5s		
Load life	10	5	70°C±2°C, 1000h, Rated current×100%, 1.5h 0N / 0.5h 0FF cycle		
Load life moisture	10	3	40°C±2°C, 90%~95%RH, 1000h, Rated current×100%, 1.5h ON/0.5h OFF cycle		
Rapid change of temperature	10	5	-55°C (30min) / +125°C (30min) 10 cycles		
Resistance to solvent	No evidence of damages to protective.	_	Conforming to MIL-STD-202F		
Residual resistance	10kΩ or more	_	Measure DC resistance after fusing		

■Precautions for Use

- The substrate material of TF10BN applies ceramics to achieve good fusing characteristics. Please keep away from oxygen gas/liquid because such environment may deteriorate element strength and the performance by glass component corrosion.
- When you select fuse product, please make sure to confirm "Precautions for Use of Fusing Components" in this catalogue and ask KOA sales.